

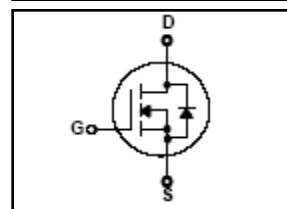
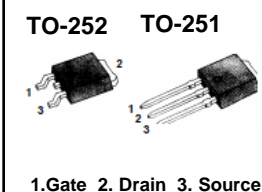
HD840U/HU840U

500V N-Channel MOSFET

FEATURES

- Originative New Design
- Superior Avalanche Rugged Technology
- Robust Gate Oxide Technology
- Very Low Intrinsic Capacitances
- Excellent Switching Characteristics
- Unrivalled Gate Charge : 25 nC (Typ.)
- Extended Safe Operating Area
- Lower $R_{DS(ON)}$: 0.75 Ω (Typ.) @ $V_{GS}=10V$
- 100% Avalanche Tested

$BV_{DSS} = 500 V$
 $R_{DS(on) typ} = 0.75 \Omega$
 $I_D = 8.0 A$



Absolute Maximum Ratings $T_C=25^\circ C$ unless otherwise specified

Symbol	Parameter	Value	Units
V_{DSS}	Drain-Source Voltage	500	V
I_D	Drain Current – Continuous ($T_C = 25^\circ C$)	8.0	A
	Drain Current – Continuous ($T_C = 100^\circ C$)	5.4	A
I_{DM}	Drain Current – Pulsed (Note 1)	36	A
V_{GS}	Gate-Source Voltage	± 30	V
E_{AS}	Single Pulsed Avalanche Energy (Note 2)	360	mJ
I_{AR}	Avalanche Current (Note 1)	8.0	A
E_{AR}	Repetitive Avalanche Energy (Note 1)	13.5	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.5	V/ns
P_D	Power Dissipation ($T_C = 25^\circ C$) – Derate above $25^\circ C$	135	W
		1.07	W/ $^\circ C$
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150	$^\circ C$
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	$^\circ C$

Thermal Resistance Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	0.93	$^\circ C/W$
$R_{\theta CS}$	Case-to-Sink	0.5	--	
$R_{\theta JA}$	Junction-to-Ambient	--	62.5	

Electrical Characteristics $T_C=25\text{ }^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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On Characteristics

V_{GS}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	2.0	--	4.0	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\ \text{V}, I_D = 4.0\ \text{A}$	--	0.75	0.85	Ω

Off Characteristics

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\ \text{V}, I_D = 250\ \mu\text{A}$	500	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\ \mu\text{A}$, Referenced to $25\text{ }^\circ\text{C}$	--	0.57	--	$\text{V}/^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 500\ \text{V}, V_{GS} = 0\ \text{V}$	--	--	1	μA
		$V_{DS} = 400\ \text{V}, T_C = 125\text{ }^\circ\text{C}$	--	--	10	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30\ \text{V}, V_{DS} = 0\ \text{V}$	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30\ \text{V}, V_{DS} = 0\ \text{V}$	--	--	-100	nA

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 25\ \text{V}, V_{GS} = 0\ \text{V},$ $f = 1.0\ \text{MHz}$	--	1000	1300	pF
C_{oss}	Output Capacitance		--	130	170	pF
C_{rss}	Reverse Transfer Capacitance		--	20	26	pF

Switching Characteristics

$t_{d(on)}$	Turn-On Time	$V_{DS} = 250\ \text{V}, I_D = 8.0\ \text{A},$ $R_G = 25\ \Omega$	--	25	50	ns	
t_r	Turn-On Rise Time		--	60	120	ns	
$t_{d(off)}$	Turn-Off Delay Time		(Note 4,5)	--	130	260	ns
t_f	Turn-Off Fall Time			--	90	180	ns
Q_g	Total Gate Charge	$V_{DS} = 400\ \text{V}, I_D = 8.0\ \text{A},$ $V_{GS} = 10\ \text{V}$	--	25	33	nC	
Q_{gs}	Gate-Source Charge		(Note 4,5)	--	6	--	nC
Q_{gd}	Gate-Drain Charge			--	12	--	nC

Source-Drain Diode Maximum Ratings and Characteristics

I_S	Continuous Source-Drain Diode Forward Current	--	--	8.0	A	
I_{SM}	Pulsed Source-Drain Diode Forward Current	--	--	36		
V_{SD}	Source-Drain Diode Forward Voltage	$I_S = 9.0\ \text{A}, V_{GS} = 0\ \text{V}$	--	--	1.4	V
t_{rr}	Reverse Recovery Time	$I_S = 9.0\ \text{A}, V_{GS} = 0\ \text{V}$ $di_F/dt = 100\ \text{A}/\mu\text{s}$ (Note 4)	--	335	--	ns
Q_{rr}	Reverse Recovery Charge		--	2.95	--	μC

Notes ;

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $L=8\text{mH}, I_{AS}=8.0\text{A}, V_{DD}=50\text{V}, R_G=25\Omega,$ Starting $T_J=25\text{ }^\circ\text{C}$
3. $I_{SD}\leq 9.0\text{A}, di/dt\leq 200\text{A}/\mu\text{s}, V_{DD}\leq BV_{DSS},$ Starting $T_J=25\text{ }^\circ\text{C}$
4. Pulse Test : Pulse Width $\leq 300\mu\text{s},$ Duty Cycle $\leq 2\%$
5. Essentially Independent of Operating Temperature

Typical Characteristics

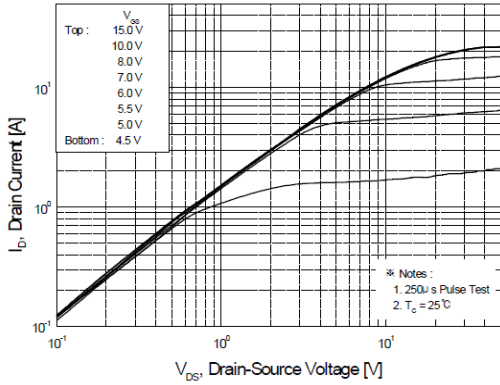


Figure 1. On Region Characteristics

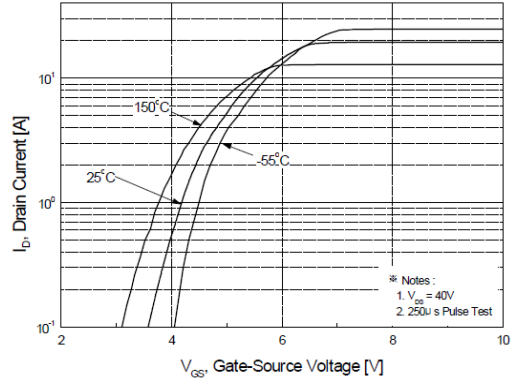


Figure 2. Transfer Characteristics

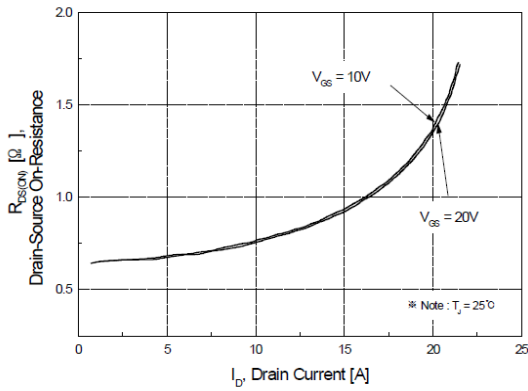


Figure 3. On Resistance Variation vs Drain Current and Gate Voltage

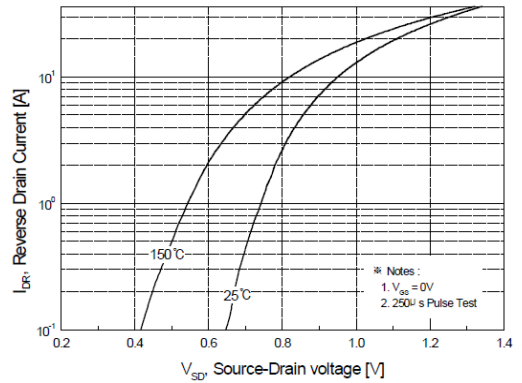


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

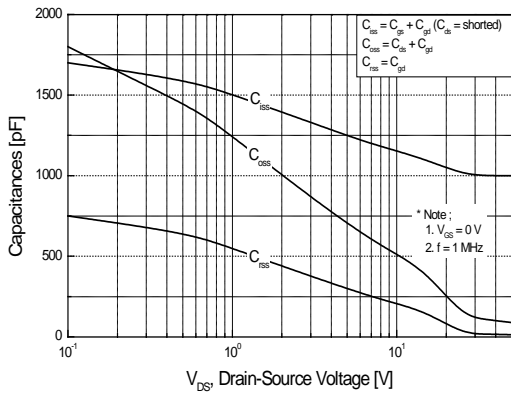


Figure 5. Capacitance Characteristics

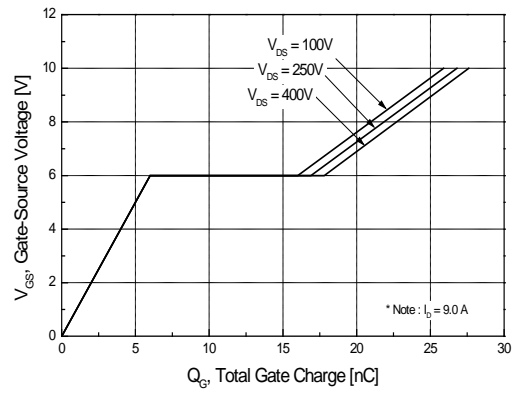


Figure 6. Gate Charge Characteristics

Typical Characteristics (continued)

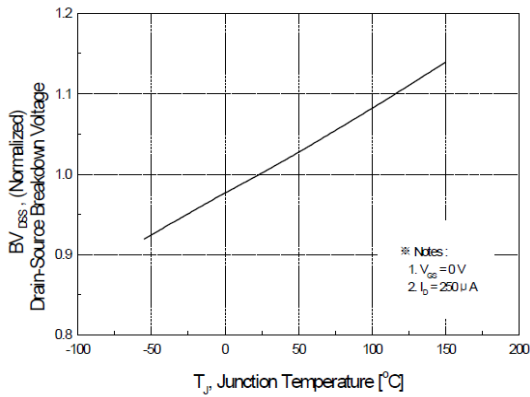


Figure 7. Breakdown Voltage Variation vs Temperature

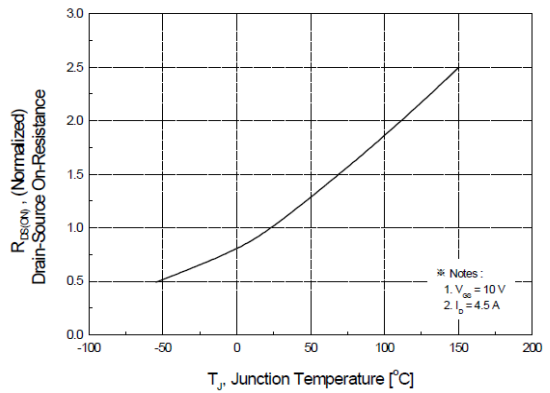


Figure 8. On-Resistance Variation vs Temperature

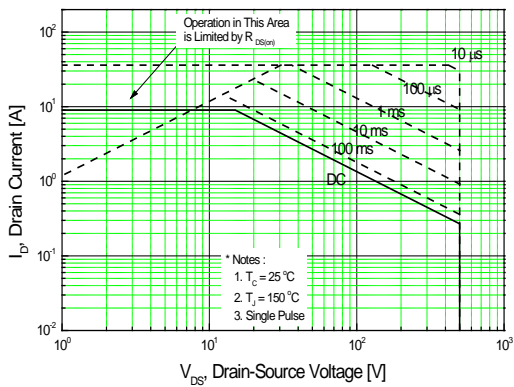


Figure 9. Maximum Safe Operating Area

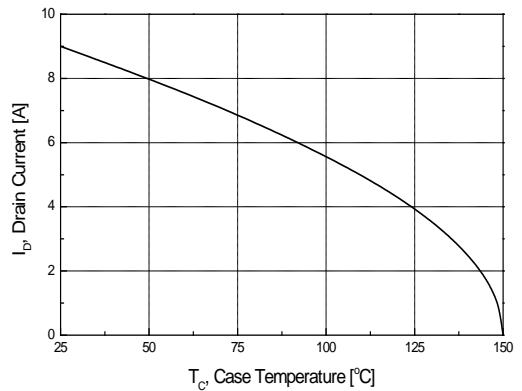


Figure 10. Maximum Drain Current vs Case Temperature

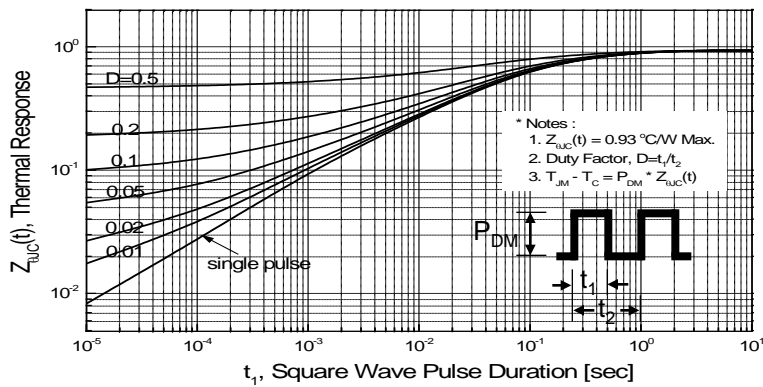


Figure 11. Transient Thermal Response Curve

Fig 12. Gate Charge Test Circuit & Waveform

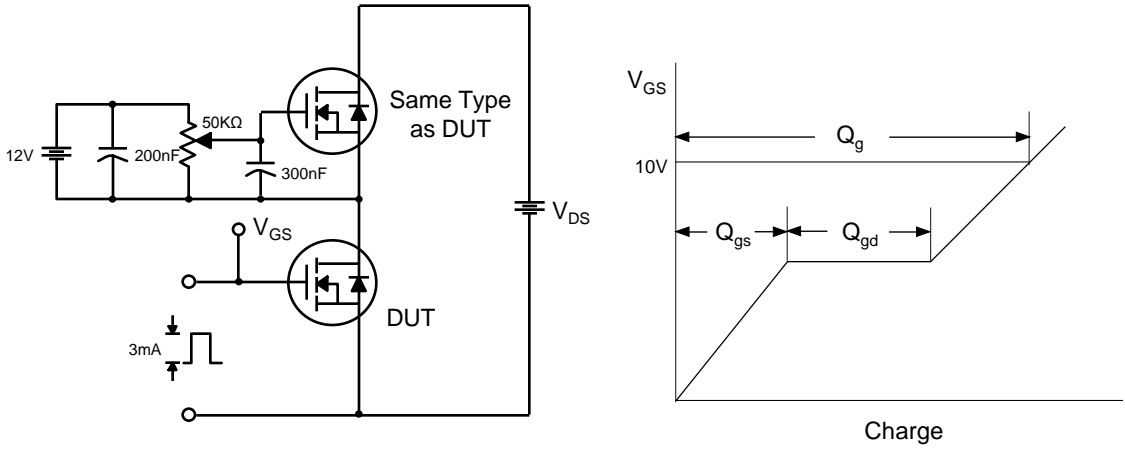


Fig 13. Resistive Switching Test Circuit & Waveforms

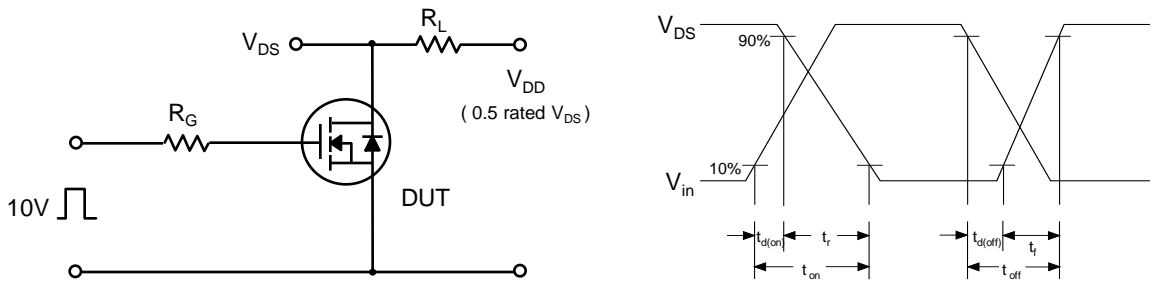


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

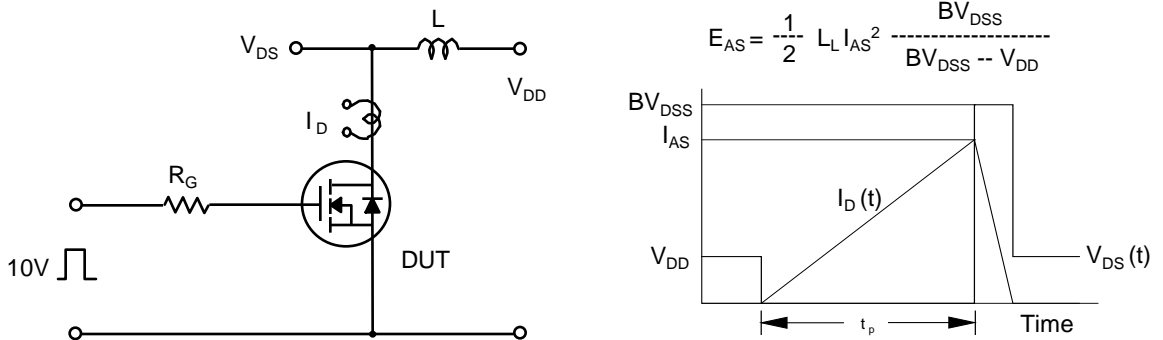
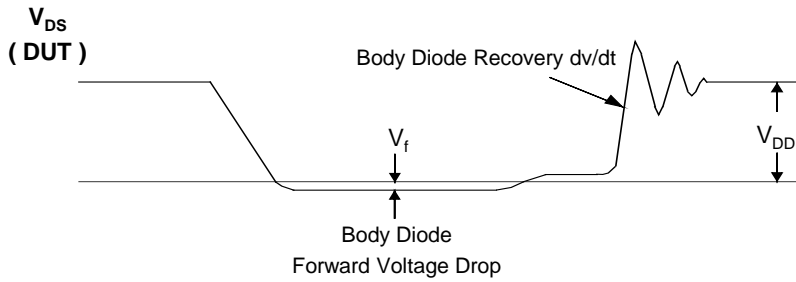
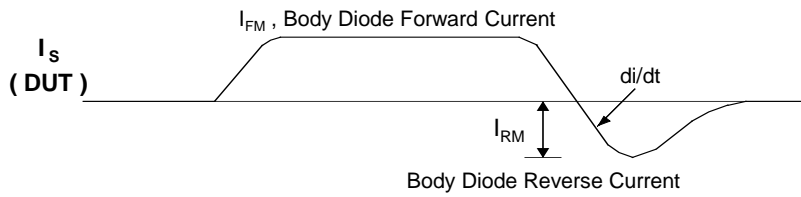
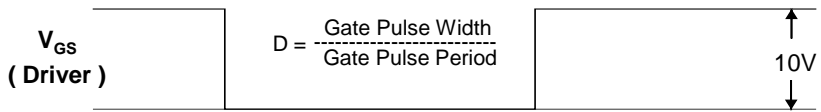
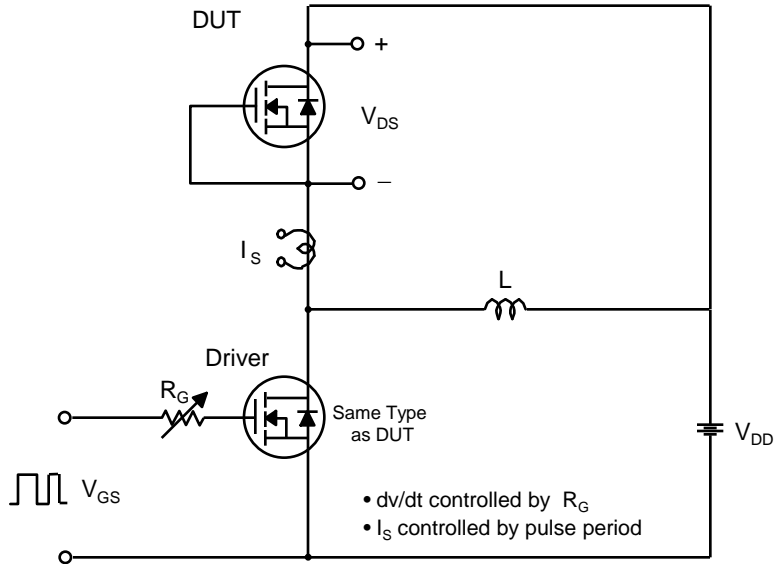
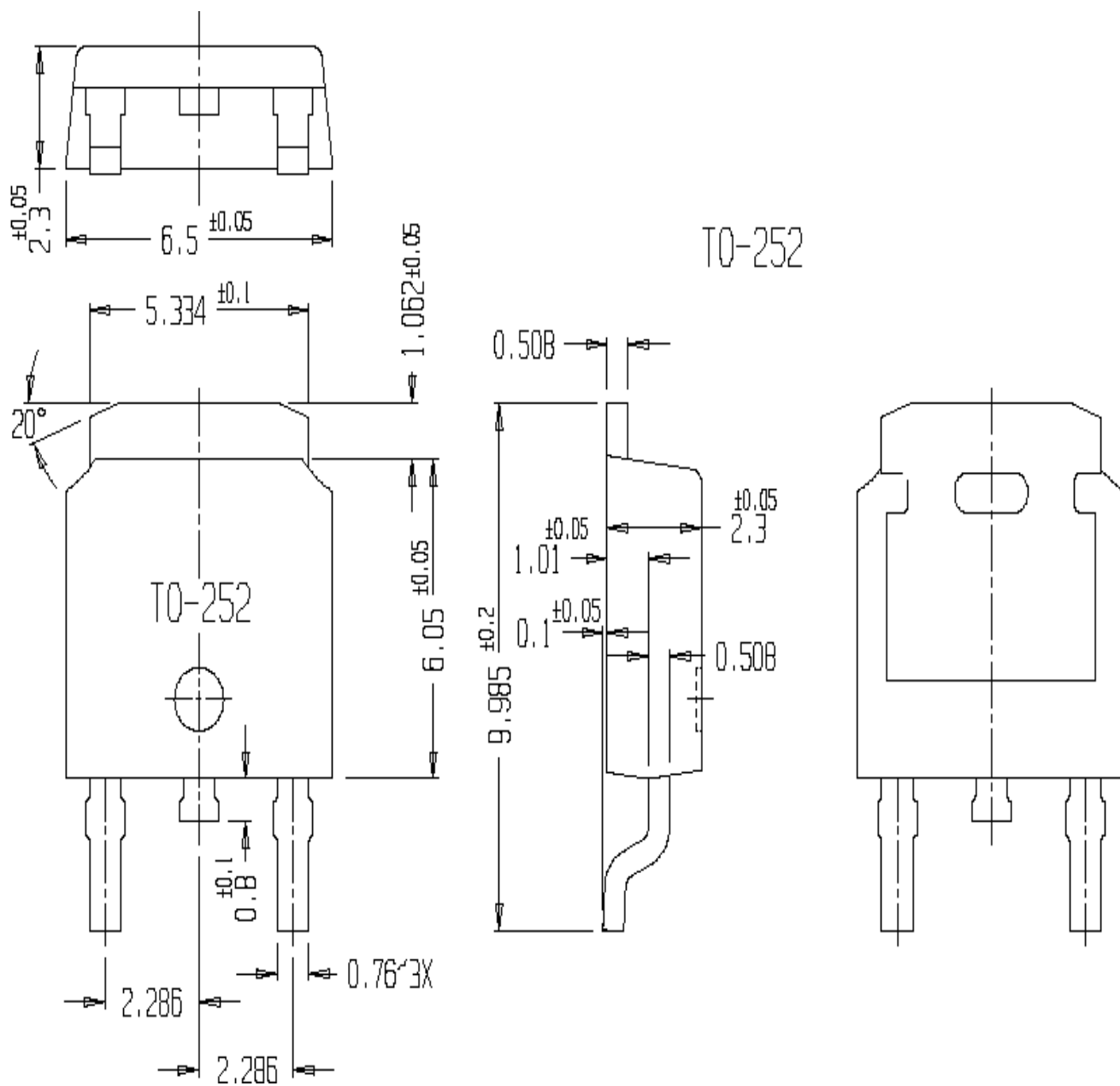
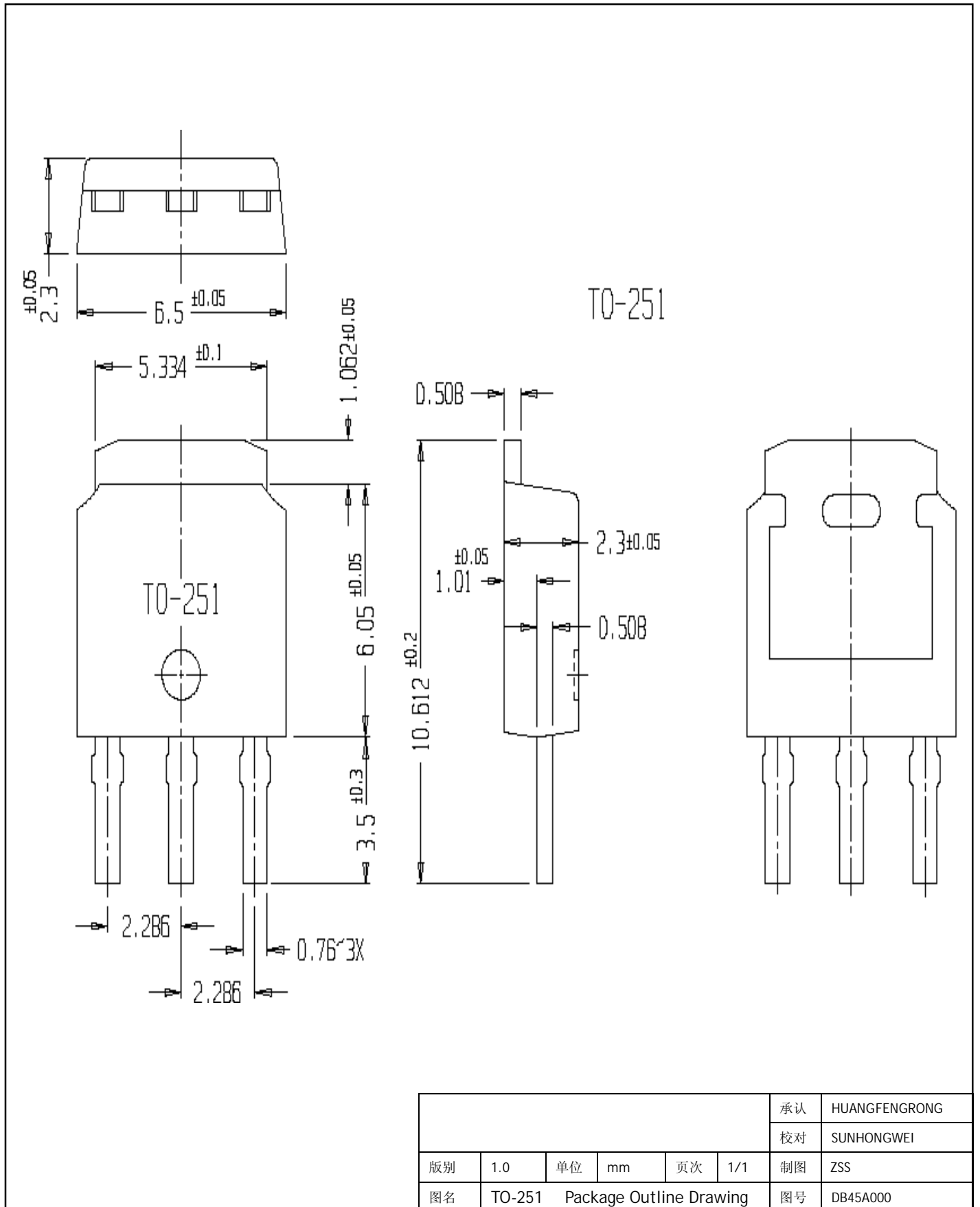


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms





						承认	HUANGFENGRONG
						校对	SUNHONGWEI
版别	1.0	单位	mm	页次	1/1	制图	ZSS
图名	TO-252 Package Outline Drawing					图号	DB45B000



						承认	HUANGFENGRONG
						校对	SUNHONGWEI
版别	1.0	单位	mm	页次	1/1	制图	ZSS
图名	TO-251 Package Outline Drawing					图号	DB45A000

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